

# **DATA SHEET**

SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS

Automotive grade X5R/X6S

\$12nF\$ to  $~2.2~\mu F$  RoHS compliant & Halogen Free



**YAGEO** 



### SCOPE

This specification describes Automotive grade X5R/X6S series chip capacitors with lead-free terminations and used for automotive infotainment system.

### **APPLICATIONS**

Entertainment applications Comfort applications Information applications

Do not use these products in application critical to passenger safety and car driving function

### **FEATURES**

- AEC-Q200 complaint
- MSL class: MSL I
- · Soldering is compliant with J-STD-020D
- · Reduce environmentally hazardous waste
- · High component and equipment reliability
- The capacitors are 100% performed by automatic optical inspection prior to taping.

### ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

### **GLOBAL PART NUMBER**

AC XXXX X X XXX X B X XXX

(1) (2) (3) (4) (5) (6) (7)

### (I) SIZE – INCH BASED (METRIC)

0201 (0603) / 0402 (1005) / 0603 (1608) / 0805 (2012) / 1206 (3216)/ 1210 (3225)

### (2) TOLERANCE

 $| = \pm 5\%$ 

 $K = \pm 10\%$ 

 $M = \pm 20\%$ 

### (3) PACKING STYLE (SEE TABLE 5)

R = Paper/PE taping reel; Reel 7 inch

K = Blister taping reel; Reel 7 inch

P = Paper/PE taping reel; Reel 13 inch

F = Blister taping reel; Reel 13 inch

### (4) TC MATERIAL

X5R

X6S

### (5) RATED VOLTAGE

 $4 = 4 \ \lor$ 

5 = 6.3 V

6 = 10 V

7 = 16 V

8 = 25 V

G = 35 V

9 = 50 V

### (6) PROCESS

B = Class 2 MLCC

### (7) CAPACITANCE VALUE

2 significant digits + number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example:  $121 = 12 \times 10^{1} = 120 \text{ pF}$ 

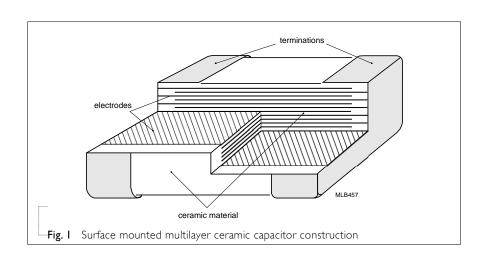


### CONSTRUCTION

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The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

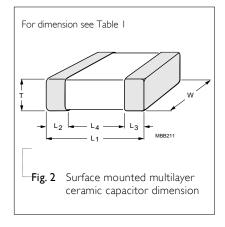
The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (Matte Sn). The terminations are leadfree. A cross section of the structure is shown in Fig. I.



### **DIMENSION**

TYDE	l (mm)	\A/ ()	T (MM)	L <sub>2</sub> / L <sub>3</sub> (	mm)	L <sub>4</sub> (mm)
TYPE	L <sub>I</sub> (mm)	W (mm)	T (MM)	min.	max.	min.
0201	0.6 ±0.03	0.3±0.03	0.3±0.03	0.10	0.20	0.20
0402	1.0 ±0.05	0.5 ±0.05	0.5 ±0.05	0.15	0.35	0.30
0603	1.6 ±0.10	0.8 ±0.10	0.8 ±0.10	0.20	0.50	0.60
	2.0 ±0.10	1.25 ±0.10	0.6 ±0.10			
0805	20.000	125 1020	0.85 ±0.10	0.25	0.75	0.70
	2.0 ±0.20	1.25 ±0.20	1.25 ±0.20			
	3.2 ±0.15	17.1015	0.6 ±0.10			1.40
		1.6 ±0.15	0.85 ±0.10	0.25		
1206	3.2 ±0.30	14.000	1.25 ±0.20		0.75	
		1.6 ±0.20	1.6 ±0.20			
	3.2 ±0.30	1.6 ±0.30	1.6 ±0.30			
	3.2 +0.20	2.5 ±0.20	0.85 ±0.10			
	J.Z ±0.Z0	Z.3 ±0.20	1.25 ±0.20			
1210	3.2 ±0.30	2.5 ±0.20	1.6 ±0.20	0.25	0.75	1.40
	J.Z ±0,J0	∠,J ⊥∪,∠∪	2.0 ±0.20			
	3.2 ±0.40	2.5 ±0.30	2.5 ±0.20			

### **OUTLINES**





### CAPACITANCE RANGE & THICKNESS FOR X5R

Table 2	Sizes fron	n 0201 to 0402			
CAP.		0201		0402	0805
		6.3V	10V	6.3 V	50 V
15	nF	0.3±0.03	0.3±0.03		
22	2 nF	0.3±0.03	0.3±0.03		
33	3 nF	0.3±0.03	0.3±0.03		
47	7 nF	0.3±0.03	0.3±0.03		
68	3 nF	0.3±0.03	0.3±0.03		
100	) nF	0.3±0.03	0.3±0.03		
150	) nF			0.5±0.05	
220	) nF			0.5±0.05	
330	) nF			0.5±0.05	
470	) nF			0.5±0.05	
680	) nF			0.5±0.05	
1.0	) uF			0.5±0.05	
2.2	2 uF				1.25±0.2

### NOTE

1. Values in shaded cells indicate thickness class in mm

### CAPACITANCE RANGE & THICKNESS FOR X6S

Table 3	Sizes 020	I	
CAP.		0201	
		6.3V	10V
15	nF	0.3±0.03	0.3±0.03
22	. nF	0.3±0.03	0.3±0.03
33	nF	0.3±0.03	0.3±0.03
47	nF	0.3±0.03	0.3±0.03
68	nF	0.3±0.03	0.3±0.03
100	nF	0.3±0.03	0.3±0.03
150	nF		
220	nF		
330	nF		
470	nF		
680	nF		
1.0	uF		

### NOTE

- 1. Values in shaded cells indicate thickness class in mm
- 2. Capacitance value of non E-6 series is on request





Surface-Mount Ceramic Multilayer Capacitors | Automotive grade | ×5R/X6S | 4V to 50 V

### THICKNESS CLASSES AND PACKING QUANTITY

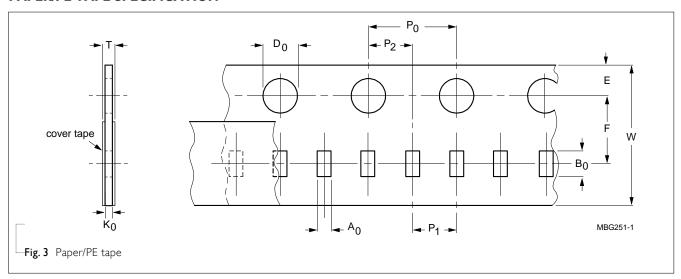
### Table 4

	TI II GI (A 1500	DA CIVII	NC CODE			QUANTIT	Y PER REEL	
SIZE CODE	CLASSIFICATION	PACKII	NG CODE	TAPE WIDTH	Ø180 MI	M / 7 INCH	Ø330 M	M / 13 INCH
		7 INCH	13 INCH		Paper	Blister	Paper	Blister
0201	0.3 ±0.03 mm	R	Р	8 mm	15,000		50,000	
0402	0.5 ±0.05 mm	R	Р	8 mm	10,000		50,000	
0603	0.8 ±0.1 mm	R	Р	8 mm	4,000		15,000	
	0.6 ±0.1 mm	R	Р	8 mm	4,000		20,000	
0805	0.85 ±0.1 mm	R	Р	8 mm	4,000		15,000	
	1.25 ±0.2 mm	K	F	8 mm		3,000		10,000
	0.6 ±0.1 mm	R	Р	8 mm	4,000		20,000	<del></del>
1206	0.85 ±0.1 mm	R	Р	8 mm	4,000		15,000	
1200	1.0/1.15 ±0.1 mm	K	F	8 mm		3,000		10,000
	1.25 ±0.2 mm	K	F	8 mm		3,000		10,000
	0.85 ±0.1 mm	K	F	8 mm		4,000		10,000
	1.15 ±0.1 mm	K	F	8 mm		3,000		10,000
1210	1.25 ±0.2 mm	K	F	8 mm		3,000		10,000
	2.0 ±0.2 mm	K		8 mm		2,000		
	2.5 ±0.2 mm	K		8 mm		1,000		



### Surface-Mount Ceramic Multilayer Capacitors | Automotive grade | x5R/X6S | 4V to 50 V

### **PAPER/PE TAPE SPECIFICATION**



**Table 5** Dimensions of paper/PE tape for relevant chip size; see Fig.3

SIZE	SYMBOL Unit: mm										
CODE	$A_0$	B <sub>0</sub>	W	E	F	$P_0^{(l)}$	P <sub>I</sub>	P <sub>2</sub>	$ØD_0$	K <sub>0</sub>	Т
0201	0.39 ± 0.06	0.70 ± 0.06	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.05	2.0 ± 0.05	2.0 ± 0.05	1.55 ± 0.03	0.38 ± 0.05	(0.47 / 0.55)±0.10
0402	0.70 ± 0.15	1.21 ± 0.12	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.05	2.0 ± 0.05	2.0 ± 0.05	1.50 +0.1 /-0	(0.75 / 0.60)±0.10	(0.85 / 0.70)±0.10
0603	1.05 ± 0.14	1.86 ± 0.13	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	1.50 +0.1 /-0	(1.05 / 0.95 / 0.75)±0.10	(1.15 / 1.05 / 0.85)±0.10
0805	1.50 ± 0.15	2.26 ± 0.20	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	1.50 +0.1 /-0	(1.05 / 0.95 / 0.75)±0.10	(1.15 / 1.05 / 0.85)±0.10
1206	1.90 ± 0.15	3.50 ± 0.20	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	1.50 +0.1 /-0	(0.95 / 0.75)±0.10	(1.05 / 0.85)± 0.10

### NOTE

1.  $P_0$  pitch tolerance over any 10 pitches is  $\pm 0.2$  mm

### **BLISTER TAPE SPECIFICATION**

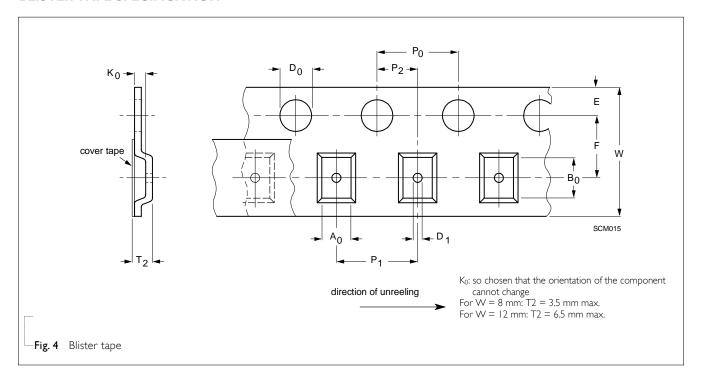


Table 6 Dimensions of blister tape for relevant chip size; see Fig.4

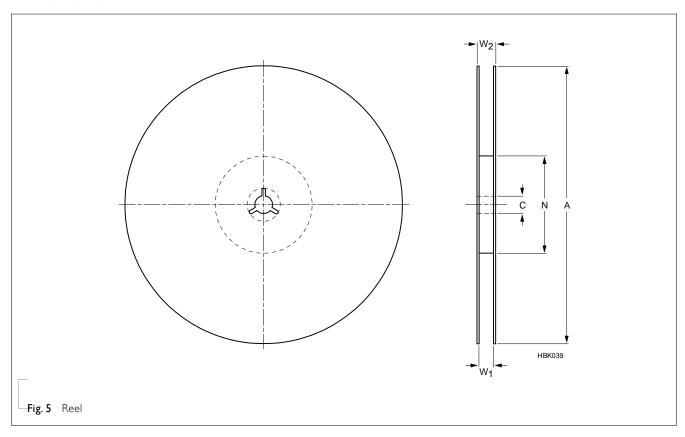
	SYM	SYMBOL Unit: mm														
SIZE CODE	$A_0$		B <sub>0</sub>		K <sub>0</sub>		W	Е	F	$ØD_0$	ØD <sub>I</sub>	P <sub>0</sub> (2)	P <sub>I</sub>	P <sub>2</sub>	T2	
	Min.	Max.	Min.	Max.	Min.	Max.					Min.				Min.	Max.
0805	1.29	1.65	2.09	2.60	1.25	1.62	8.I ±0.20	1.75 ±0.1	3.5 ±0.05	1.5 +0.1/-0.0	1 +0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.30	1.67
1206	1.65	2.12	3.30	3.75	1.22	2.15	8.I ±0.20	1.75 ±0.1	3.5 ±0.05	1.5 +0.1/-0.0	1 +0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.27	2.20
1210	2.55	3.02	3.31	3.88	0.97	2.92	8.I ±0.20	1.75 ±0.1	3.5 ±0.05	1.5 +0.1/-0.0	1 +0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.02	2.97

### NOTE

- I. Typical capacitor displacement in pocket
- 2.  $P_0$  pitch tolerance over any 10 pitches is  $\pm 0.2$  mm



### **REEL SPECIFICATION**



**Table 7** Reel dimensions; see Fig.5

TARE WIDTH	SYMBOL							
TAPE WIDTH	A	N	С	$W_1$	W <sub>2max</sub> .			
8 (Ø178 mm/7")	178 ±1.0	60 ±1.0	13 +0.50/-0.20	9.4 ±1.5	14.4			
8 (Ø330 mm/13")	330 ±1.0	100 ±1.0	13 +0.50/-0.20	9.0 ±0.2	14.4			
12 (Ø178 mm/7")	178 ±1.0	60 ±1.0	13 +0.50/-0.20	13.4 ±1.5	18.4			

### **PROPERTIES OF REEL**

Material: polystyrene

Surface resistance:  $<10^{10}$  X/sq.



**Surface-Mount Ceramic Multilayer Capacitors** Automotive grade ×5R/X6S 4V to 50 V

### **ELECTRICAL CHARACTERISTICS**

### X5RX6S DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C - Relative humidity: 25% to 75% - Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

DESCRIPTION Table 8					VALUE
Capacitance toler: X5R/X6S	ance				±5% <sup>(1)</sup> , ±10%, ±20%
Operating temper	erature range:				
X5R					−55 °C to +85 °C
X6S					-55 °C to +105 °C
•	ance change as a function of aracteristic/coefficient):	temperature			±15% ±22%
Dissipation factor	(D.F.)				
X5R	0201	0402	0603	0805	Spec.
6.21/		120nF to 1µF			≤7%
6.3V	12nF to 100nF				≤10%
10V	12nF to 100nF				≤10%
				2.2uF	≤10%
50V				Z.ZUF	210/0
50V X6S	0201	0402		Z,ZUF	210/0
	<b>020 I</b> 12nF to 100nF	0402		Z,ZUF	≤10% ≤10%

### Insulation resistance (I.R.)

X5R	0201	0402	0603	0805	25°C	Max. operating temperature
6.3V	12nF to 100nF	120nF to 1µF			≥100	≥10
10V	12nF to 100nF				≥100	≥10
50V				2.2uF	≥50	≥5
X6S	0201	0402				
6.3V	12nF to 100nF				≥100	≥10
10V	12nF to 100nF	·	·		≥100	≥10

### NOTE

I. Capacitance tolerance ±5% doesn't available for X5R/X6S full product range, please contact local sales force before order







### **Surface-Mount Ceramic Multilaver Capacitors** Automotive grade x5R/X6S 4V to 50 V

### **SOLDERING RECOMMENDATION**

Table 9

SOLDERING	SIZE					
METHOD	0201	0402	0603	0805	1206	≥ 1210
Reflow	Reflow only	≥ 0.1 µF	≥ 1.0 µF	≥ 2.2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave		< 0.1 µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	

### **SOLDERING CONDITIONS**

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C
- Endurance: 95 to 120 seconds
- Cycles: 3 times

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202G-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

### TESTS AND REQUIREMENTS

Table 10 Test procedures and requirements

NO	AEC-Q2000 TEST	TEST METHOD	REQUIREMENTS
ı	Pre-and Post-stress Electrical Test		
		Preconditioning;	No visual damage
	Temperature Cycling	150 +0/–10 °C for 1 hour, then keep for 24 ±1 hours at room temperature 1000 cycles with following detail:	ΔC/C ±10%
2		15 minutes at –55 °C	D.F. meet initial specified value
		I5 minutes at I25 °C Recovery time 24 ±4 hours	I.R. meet initial specified value
3	Destructive Physical Analysis	Only applies to SMD ceramics. Electrical test not required.	



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NO	AEC-Q2000 TEST	TEST METHOD	REQUIREMENTS
		I. Preconditioning:  150 +0/-10 °C /1 hour, then keep for	No visual damage after recovery
		24 ± 1 hour at room temp 2. Initial measure:	ΔC/C ±15%
4	Humidity Bias	Parameter: I.R. Measuring voltage: $1.3V \pm 1.5$ Volts Note: Series with 100 K $\Omega$ 3. Test condition:	D.F. Less than 200% of initial spec.
		<ul> <li>85 °C, 85% R.H. connected with 100 KΩ resistor, applied 1.5V/U<sub>r</sub> for 1,000 hours.</li> <li>4. Recovery: 24 ±2 hours</li> <li>5. Final measure: C.D.I.R.</li> </ul>	I.R.  The insulation resistance shal be greater than 10% of initial spec.
		I. Preconditioning:  150 +0/-10 °C /I hour, then keep for  24 ± I hour at room temp  2. Initial measure:	No visual damage  ΔC/C: ±20%
5	High Temperature	Spec: refer to initial spec C, D, I.R.  3. Endurance test:  Temperature: X5R:85 °C X6S:105 °C  Specified stress voltage applied for 1,000 hours:  Applied 100% U <sub>r</sub>	D.F. Less than 200% of initial spec.
	Operational Life	Recovery time: 24 ±2 hours Final measure: C, D, I.R.	I.R.  The insulation resistance shall be greater than 10% of initial
		Note: If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirement shall be met.	spec
6	External Visual	Any applicable method using × 10 magnification	In accordance with specification
7	Physical Dimension	Verify physical dimensions to the applicable device	In accordance with

specification.

I. Per MIL-STD-202 Method 215

3. Solvent 2 : Terpene defluxer

2. Solvent I: I part (by volume) of isopropyl alcohol

4. Solvent 3:42 parts (by volume) of water

monomethyl ether

3 parts (by volume) of mineral spirits

I part (by volume) of propylene glycol

I part (by volume) of monoethanolamine



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Physical Dimension

Resistance to Solvents

specification

 $\Delta$ C/C  $\pm$ 10%

No visual damage

D.F.: Within initial spec.

I.R.: Within initial spec.

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# Surface-Mount Ceramic Multilayer Capacitors | Automotive grade | X5R/X6S | 4V to 50 V

NO	AEC-Q2000 TEST	TEST METHOD	REQUIREMENTS
9	Mechanical Shock	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500 g's Duration: 0.5 ms Velocity change: 15.4 ft/s Waveform: Half-sin	D.F. Within initial specified value  I.R. Within initial specified value
10	Vibration	5 g's for 20 minutes, 12 cycles each of 3 orientations. 10-2000 Hz.	ΔC/C ±10%  D.F: meet initial specified value  I.R. meet initial specified value
11	Resistance to Soldering Heat	Precondition: $150 \pm 0/-10$ °C for I hour, then keep for $24 \pm 1$ hours at room temperature  Preheating: for size $\leq 1206$ : $120$ °C to $150$ °C for I minute  Preheating: for size $\geq 1206$ : $100$ °C to $120$ °C for I minute  and $170$ °C to $200$ °C for I minute  Solder bath temperature: $260 \pm 5$ °C  Dipping time: $10 \pm 0.5$ seconds  Recovery time: $24 \pm 2$ hours	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned $\Delta C/C \pm 10\%$ D.F. within initial specified value  I.R. within initial specified value
12	ESD	Per AEC-Q200-002  A component passes a voltage level if all components stressed at the voltage level pass.  YNMOO  FAIL PASS  FAIL P	



## Surface-Mount Ceramic Multilayer Capacitors | Automotive grade | ×5R/X

NO	AEC-Q2000 TEST		TEST METHOD	REQUIREMENTS
13	Solderability		<ol> <li>Preheat at 155°C for 4 hours. After preheating, immerse the capacitor in a solution of ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 5+0/-0.5 seconds at 235±5°C.</li> <li>Should be placed into steam aging for 8 hours±15 minutes. After preheating, immerse the capacitor in a solution of ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 5+0/-0.5 seconds at 235±5°C.</li> <li>Should be placed into steam aging for 8 hours±15 minutes.</li> </ol>	The solder should cover over 95% of the critical area of each termination.
			After preheating, immerse the capacitor in a solution of Ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 30±5 seconds at 260±5°C.	
		Capacitance	At 25°C, 24 hours after annealing f = 1 KHz, measuring at voltage 1 Vrms at 25 °C	
	Electrical Characterization	Dissipation Factor (D.F.)	At 25°C, 24 hours after annealing f = 1 KHz, measuring at voltage 1 Vrms at 25 °C	In according with specification on Table 8
		Insulation Resistance (I.R.)	At Ur (DC) for I minute	In according with specification on Table 8
14		Temperature coefficient	Capacitance shall be measured by the steps shown in the following table.  The capacitance change should be measured after 5 min at each specified temperature stage.	Δ C/C X5R: ±15% X6S: ±22%
			Step Temperature(°C)  a 25±2  b Lower temperature±3°C  c 25±2  d Upper Temperature±2°C  e 25±2	
			Capacitance Change shall be calculated from the formula as below $\Delta C = \frac{C2 - C1}{C1} \times 100\%$ C1: Capacitance at step c C2: Capacitance at step b or d	
		Voltage Proof	Specified stress voltage applied for 1~5 seconds     Ur ≤ 50 V: series applied 2.5 Ur     Charge/Discharge current is less than 50 mA	No breakdown or flashover

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NO	AEC-Q2000 TEST	TEST METHOD	REQUIREMENTS
15	Board Flex	Part mounted on a 100 mm X 40 mm FR4 PCB board, which is 1.6 ±0.2 mm thick and has a layer-thickness 35 µm ± 10 µm.  Part should be mounted using the following soldering reflow profile.  Conditions:  Test Substrate:	No visible damage  ΔC/C  X5R/X6S: ±10%    Dimension(mm)     Type   a   b   c     0201   0.3   0.9   0.3     0402   0.4   1.5   0.5     0603   1.0   3.0   1.2     0805   1.2   4.0   1.65     1206   2.2   5.0   1.65     1210   2.2   5.0   2.0
16	Terminal Strength	With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested.  This force shall be applied for 60+1 seconds.  Also the force shall be applied gradually as not to apply a shock to the component being tested.  * Apply 2N force for 0402 size.  * Apply 1N force for 0201 size.	Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body, terminals and body/terminal junction.  Before, during and after the test, the device shall comply with all electrical requirements stated in this specification.



15 16

### Surface-Mount Ceramic Multilayer Capacitors | Automotive grade

×5R/X6S 4V to 50 V

REVISION HISTORY

CHANGE NOTIFICATION DESCRIPTION REVISION DATE

Version 0 Oct. 06, 2021 - New



<sup>&</sup>quot;YAGEO reserves all the rights for revising the content of this datasheet without further notification, as long as the products itself are unchanged. Any product change will be announced by PCN."



### **Surface-Mount Ceramic Multilayer Capacitors**

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